


NOTES:

1. DIMENSIONS D & E1 DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS, BUT DO INCLUDE MOLD MISMATCH AND ARE MEASURED AT THE PARTING LINE; MOLD FLASH OR PROTRUSION SHALL NOT EXCEED 0.20 MM PER SIDE.
2. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSIONS. DAMBAR PROTRUSION TO BE 0.13 MM TOTAL IN EXCESS OF B AT MAXIMUM MATERIAL CONDITION.
3. VISUAL INDEX FEATURE WITHIN CROSSHATCHED AREA.

DIM	MIN	MAX
A	—	2.00
A1	0.05	0.25
A2	1.65	1.85
B	0.22	0.38
C	0.09	0.21
D	—	
E	7.40	8.20
E1	5.00	5.60
e	0.65	BSC
L	0.55	0.95
R	0.09	—

		14/16 PIN		20 PIN		24 PIN		28 PIN	
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX
D		5.90	6.50	6.90	7.50	7.90	8.50	9.90	10.50

DIMENSIONS ARE IN MILLIMETERS

SIGNATURE		DATE	 Dallas Semiconductor			
DOC. CONTROL:						
ENGR. MGR:			TITLE			
MFG. ENGR:						
CHECKED BY:			MARKETING OUTLINE, 14,16,20,24,28 LD. SSOP, 5.3 MM BODY			
DRAWN BY:						
		SIZE A	FSCM NO	PART NO.		REV D
DO NOT SCALE DWG.		SCALE N/A		SHEET 1 OF 1		